

CLASS V UNDERGROUND INJECTION CONTROL APPLICATION FOR AUTHORIZATION TO INJECT REMEDIAL COMPOUNDS IN CONJUNCTION WITH A GROUNDWATER REMEDIATION PROJECT (This form was revised on 6-13-2012. See yellow highlight)

Information that must be submitted in support of a proposal to inject remedial compounds into a Class V Underground Injection Control Well(s) or Injection Point(s) for remediation projects:

- 1. Name of facility and facility owner.
- 2. Name, address and telephone number of facility owner.
- 3. Site latitude and longitude of each injection well to be used or installed, injection well/point identification numbers and a facility map with the location of the injection wells/points depicted in relation to water supply wells and monitoring wells located at and near the facility.
- 4. Documentation KDHE's Bureau of Environmental Remediation (BER) approves the injection of the remedial compounds for the remediation project.
- 5. A description of the contamination and contamination source.
- 6. Schematic of typical injection well/point design.
- 7. Name and description of the geological formation into which the remedial compound will be injected.
- 8. Approximate depth below groundsurface of injection interval and depth to groundwater.
- 9. Detailed description of the injection procedure, including proposed injection pressure. Injection pressure shall be limited to 50 psi surface pressure. If injection pressures shall exceed 50 psi, a detailed justification for the additional pressure increase must be provided. The justification must also detail all methods for monitoring the injection activities with the proposed injection pressure.
- 10. Description of the contents and characteristics of the remedial compounds to be injected.
- 11. The amount of remedial compound to be injected.
- 12. Frequency of injection.
- 13. Plugging procedure for the injection well/point including a schematic of the injection well/point after plugging.
- 14. Description of the basic chemistry of the remediation process, including products and by-products.